

N-Channel 30 V (D-S) MOSFET

PRODUCT SUMMARY			
V _{DS} (V)	R _{DS(on)} (Ω) MAX.	I _D (A)	Q _g (TYP.)
30	0.560 at V _{GS} = 4.5 V	0.5	0.72 nC
	0.620 at V _{GS} = 2.5 V	0.2	
	0.700 at V _{GS} = 1.8 V	0.2	
	1.100 at V _{GS} = 1.5 V	0.05	

FEATURES

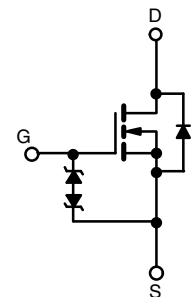
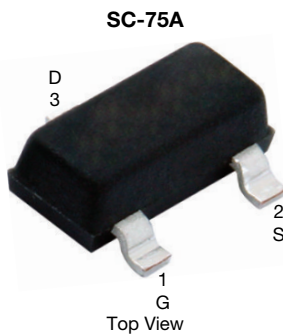
- TrenchFET® power MOSFET
- 100 % R_g tested
- Gate-source ESD protected: 1000 V
- Material categorization:
For definitions of compliance please see www.vishay.com/doc?99912



RoHS
COMPLIANT
HALOGEN
FREE

APPLICATIONS

- Load switch
- High speed switching
- DC/DC converters / boost converters
- For smart phones, tablet PCs and mobile computing



N-Channel MOSFET

Marking Code: L

Ordering Information:

Si1002R-T1-GE3 (Lead (Pb)-free and Halogen-free)

ABSOLUTE MAXIMUM RATINGS (T _A = 25 °C, unless otherwise noted)			
PARAMETER	SYMBOL	LIMIT	UNIT
Drain-Source Voltage	V _{DS}	30	V
Gate-Source Voltage	V _{GS}	± 8	
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 25 °C	0.61 ^{a,b}	A
	T _A = 70 °C	0.49 ^{a,b}	
Pulsed Drain Current (t = 100 μs)	I _{DM}	2	
Continuous Source-Drain Diode Current	T _A = 25 °C	0.18 ^{a,b}	A
Maximum Power Dissipation ^a	T _A = 25 °C	0.22 ^{a,b}	W
	T _A = 70 °C	0.14 ^{a,b}	
Operating Junction and Storage Temperature Range	T _J , T _{stg}	-55 to 150	°C

THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient ^b	R _{thJA}	t ≤ 5 s	470	565
		Steady State	560	675

Notes

- Surface mounted on 1" x 1" FR4 board.
- t = 5 s.



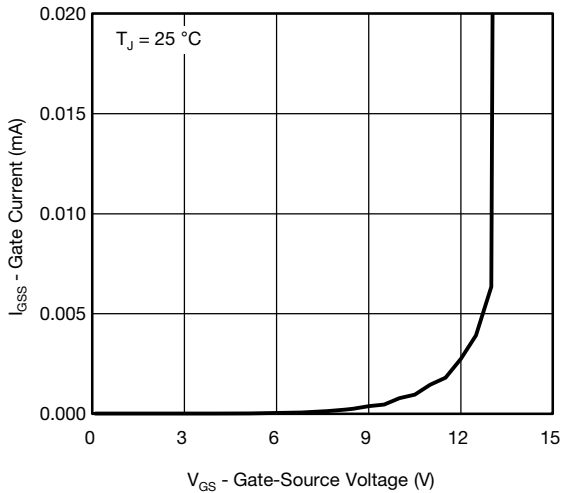
SPECIFICATIONS ($T_J = 25\text{ }^\circ\text{C}$, unless otherwise noted)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static						
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0\text{ V}$, $I_D = 250\text{ }\mu\text{A}$	30	-	-	V
V_{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	$I_D = 250\text{ }\mu\text{A}$	-	29	-	mV/ $^\circ\text{C}$
$V_{GS(th)}$ Temperature Coefficient	$\Delta V_{GS(th)}/T_J$		-	-1.8	-	
Gate-Source Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}$, $I_D = 250\text{ }\mu\text{A}$	0.4	-	1	V
Gate-Source Leakage	I_{GSS}	$V_{DS} = 0\text{ V}$, $V_{GS} = \pm 8\text{ V}$	-	-	± 30	μA
		$V_{DS} = 0\text{ V}$, $V_{GS} = \pm 4.5\text{ V}$	-	-	± 1	
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 30\text{ V}$, $V_{GS} = 0\text{ V}$	-	-	1	
		$V_{DS} = 30\text{ V}$, $V_{GS} = 0\text{ V}$, $T_J = 85\text{ }^\circ\text{C}$	-	-	3	
On-State Drain Current ^a	$I_{D(on)}$	$V_{DS} \geq 5\text{ V}$, $V_{GS} = 4.5\text{ V}$	2	-	-	A
Drain-Source On-State Resistance ^a	$R_{DS(on)}$	$V_{GS} = 4.5\text{ V}$, $I_D = 0.5\text{ A}$	-	0.450	0.560	Ω
		$V_{GS} = 2.5\text{ V}$, $I_D = 0.2\text{ A}$	-	0.500	0.620	
		$V_{GS} = 1.8\text{ V}$, $I_D = 0.2\text{ A}$	-	0.560	0.700	
		$V_{GS} = 1.5\text{ V}$, $I_D = 0.05\text{ A}$	-	0.647	1.100	
Forward Transconductance	g_{fs}	$V_{DS} = 15\text{ V}$, $I_D = 0.5\text{ A}$	-	7.5	-	S
Dynamic ^b						
Input Capacitance	C_{iss}	$V_{DS} = 15\text{ V}$, $V_{GS} = 0\text{ V}$, $f = 1\text{ MHz}$	-	36	-	pF
Output Capacitance	C_{oss}		-	9	-	
Reverse Transfer Capacitance	C_{rss}		-	5	-	
Total Gate Charge	Q_g	$V_{DS} = 15\text{ V}$, $V_{GS} = 8\text{ V}$, $I_D = 0.5\text{ A}$	-	1.2	2	nC
			$V_{DS} = 15\text{ V}$, $V_{GS} = 4.5\text{ V}$, $I_D = 0.5\text{ A}$	-	0.72	
Q_{gs}	-	0.1		-		
Q_{gd}	-	0.16		-		
Gate Resistance	R_g	$f = 1\text{ MHz}$	2.4	12.2	24.4	Ω
Turn-On Delay Time	$t_{d(on)}$	$V_{DD} = 15\text{ V}$, $R_L = 37.5\text{ }\Omega$ $I_D \equiv 0.4\text{ A}$, $V_{GEN} = 4.5\text{ V}$, $R_g = 1\text{ }\Omega$	-	6	15	ns
Rise Time	t_r		-	13	24	
Turn-Off Delay Time	$t_{d(off)}$		-	20	30	
Fall Time	t_f		-	11	20	
Drain-Source Body Diode Characteristics						
Pulse Diode Forward Current ^a	I_{SM}		-	-	2	A
Body Diode Voltage	V_{SD}	$I_S = 0.5\text{ A}$	-	0.8	1.2	V
Body Diode Reverse Recovery Time	t_{rr}	$I_F = 0.4\text{ A}$, $di/dt = 100\text{ A}/\mu\text{s}$	-	8	15	ns
Body Diode Reverse Recovery Charge	Q_{rr}		-	2	4	nC
Reverse Recovery Fall Time	t_a		-	4	-	ns
Reverse Recovery Rise Time	t_b		-	4	-	

Notes

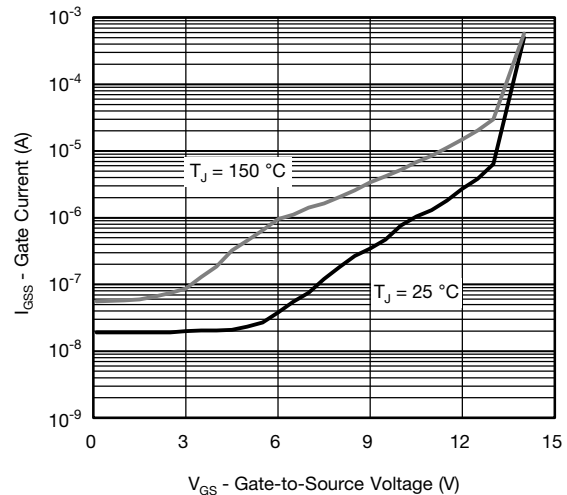
- a. Pulse test; pulse width $\leq 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$.
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

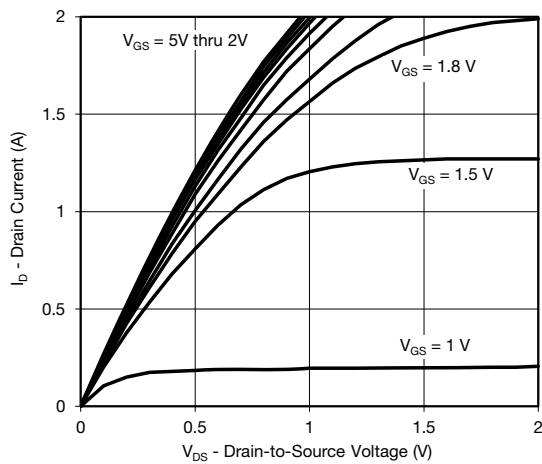
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



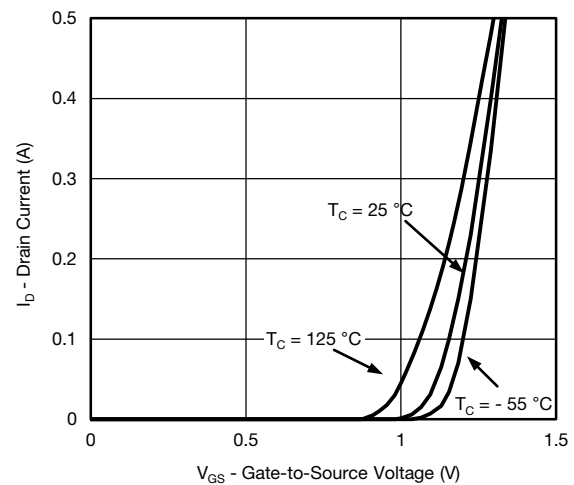
Gate Current vs. Gate-Source Voltage



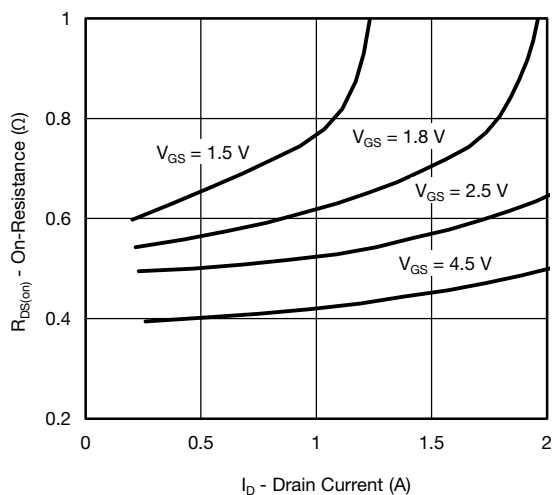
Gate Current vs. Gate-Source Voltage



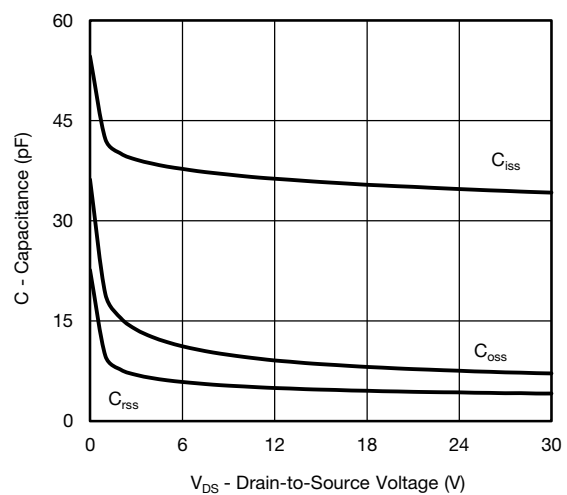
Output Characteristics



Transfer Characteristics



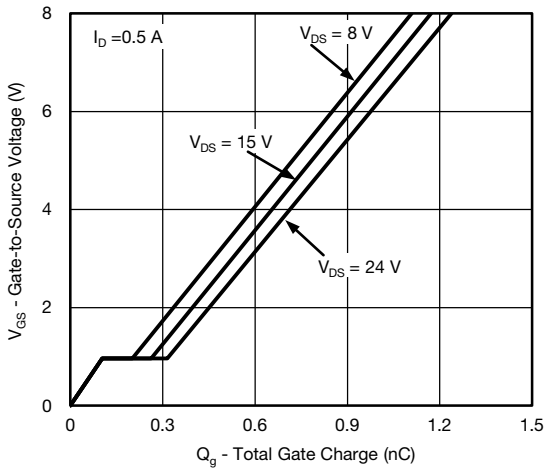
On-Resistance vs. Drain Current



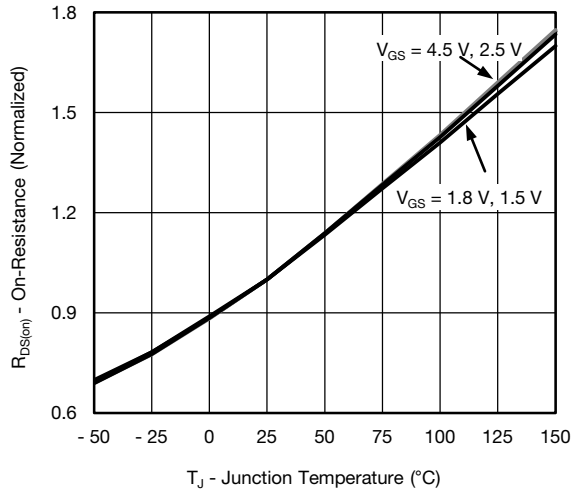
Capacitance



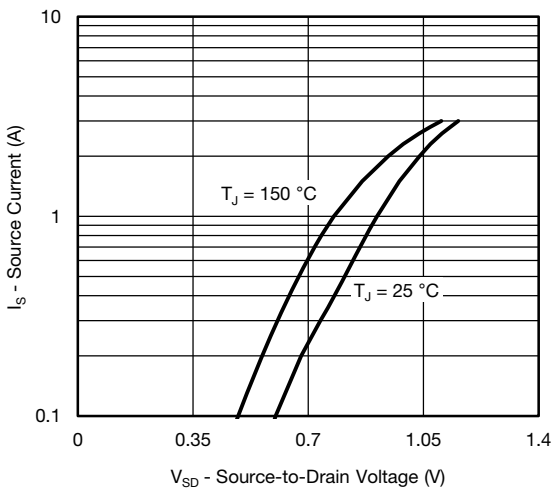
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



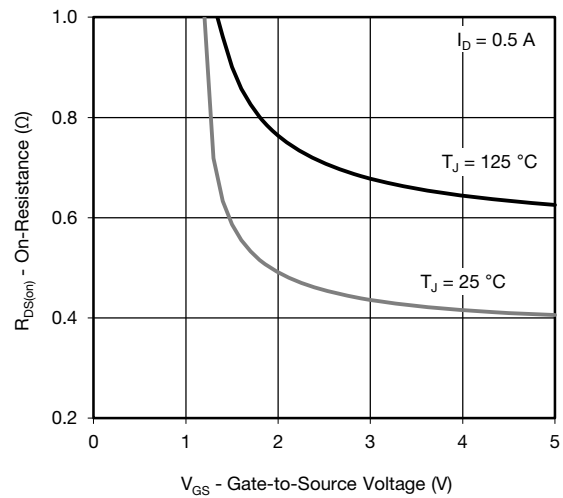
Gate Charge



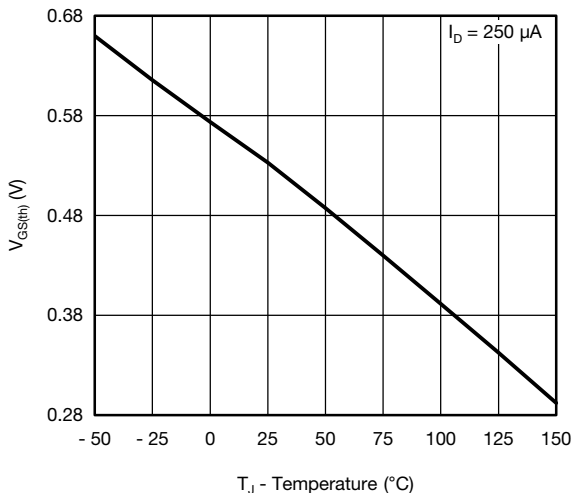
On-Resistance vs. Junction Temperature



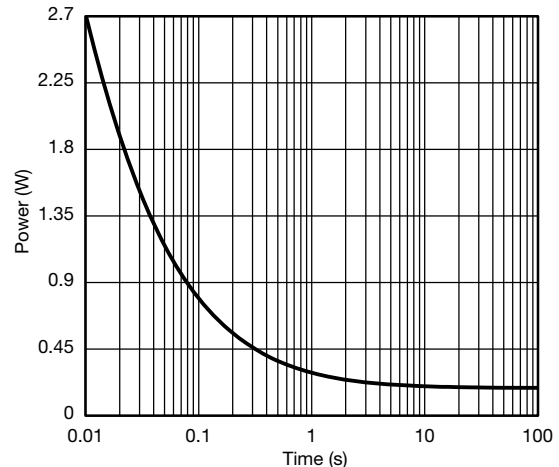
Source-Drain Diode Forward Voltage



On-Resistance vs. Gate-to-Source Voltage



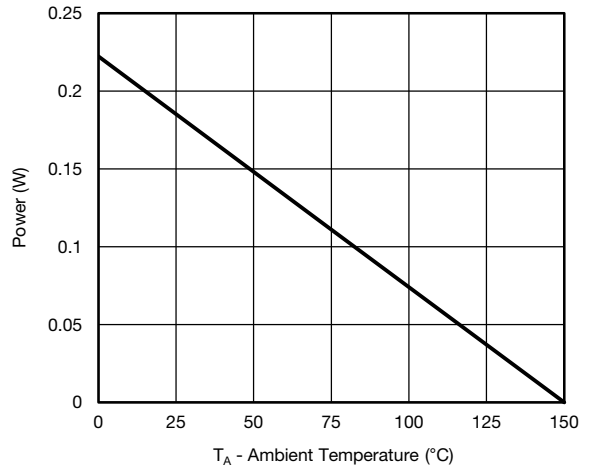
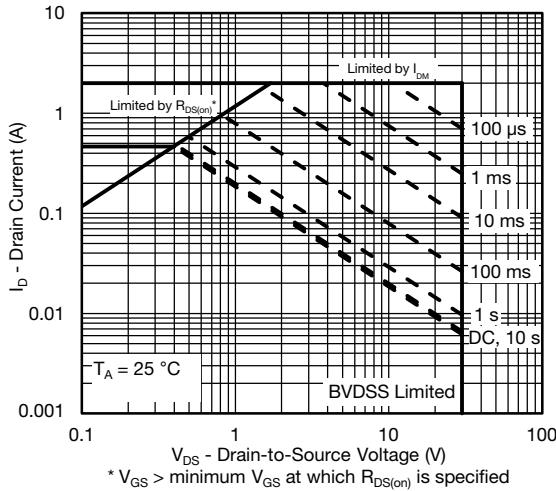
Threshold Voltage



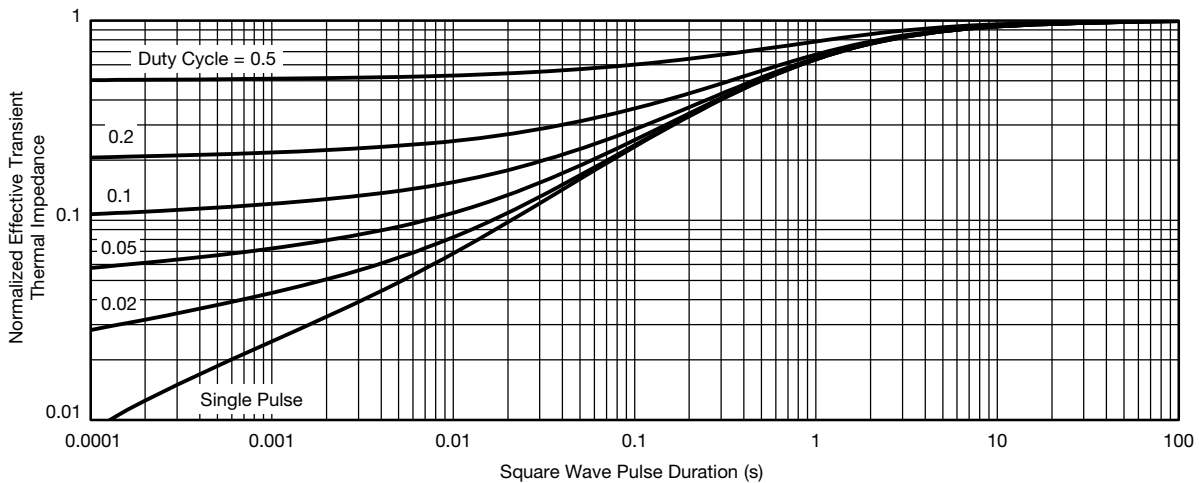
Single Pulse Power, Junction-to-Ambient



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

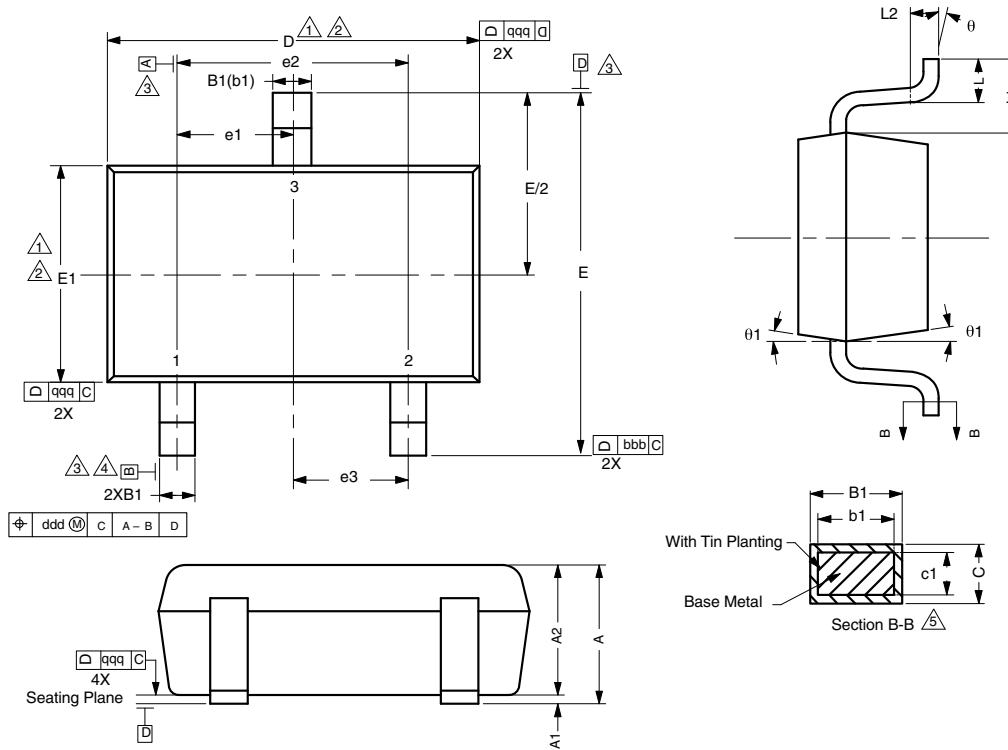


* The power dissipation P_D is based on $T_{J(max.)} = 150\text{ °C}$, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



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SC-75A: 3 Leads



DWG: 5868

Notes

Dimensions in millimeters will govern.

- 1. Dimension D does not include mold flash, protrusions or gate burrs. Mold flash protrusions or gate burrs shall not exceed 0.10 mm per end. Dimension E1 does not include Interlead flash or protrusion. Interlead flash or protrusion shall not exceed 0.10 mm per side.
- 2. Dimensions D and E1 are determined at the outmost extremes of the plastic body exclusive of mold flash, tie bar burrs, gate burrs and interlead flash, but including any mismatch between the top and bottom of the plastic body.
- 3. Datums A, B and D to be determined 0.10 mm from the lead tip.
- 4. Terminal positions are shown for reference only.
- 5. These dimensions apply to the flat section of the lead between 0.08 mm and 0.15 mm from the lead tip.

DIMENSIONS	TOLERANCES
aaa	0.10
bbb	0.10
ccc	0.10
ddd	0.10

DIM.	MILLIMETERS			NOTE
	MIN.	NOM.	MAX.	
A	-	-	0.80	
A1	0.00	-	0.10	
A2	0.65	0.70	0.80	
B1	0.19	-	0.24	5
b1	0.17	-	0.21	
c	0.13	-	0.15	5
c1	0.10	-	0.12	5
D	1.48	1.575	1.68	1, 2
E	1.50	1.60	1.70	
E1	0.66	0.76	0.86	1, 2
e1	0.50 BSC			
e2	1.00 BSC			
e3	0.50 BSC			
L	0.15	0.205	0.30	
L1	0.40 ref.			
L2	0.15 BSC			
q	0°	-	8°	
q1	4°	-	10°	

RECOMMENDED MINIMUM PADS FOR SC-75A: 3-Lead



Recommended Minimum Pads
Dimensions in Inches/(mm)

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